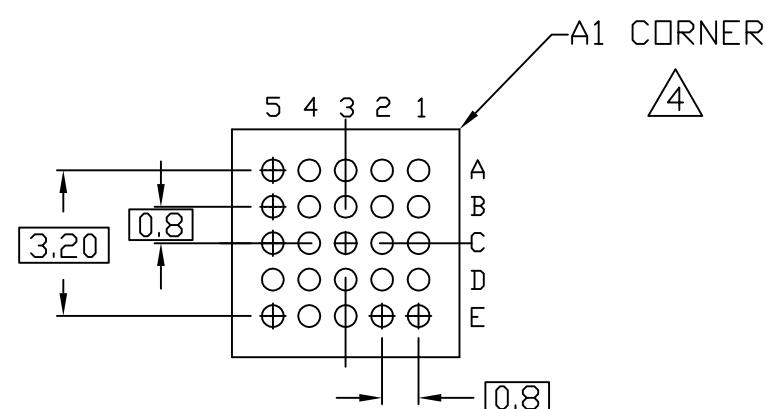
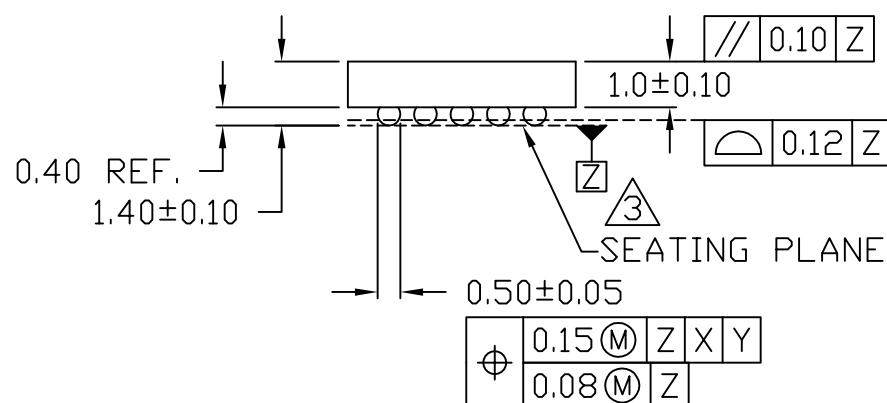


TOP VIEW



BOTTOM VIEW



SIDE VIEW

NOTES:

1. DIMENSIONS ARE IN MILLIMETERS.
2. MATERIAL MUST COMPLY WITH BANNED AND RESTRICTED SUBSTANCES SPEC # 10-0131.
3. PRIMARY DATUM Z AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
4. A1 CORNER OF THE SUBSTRATE MUST BE IDENTIFIED BY METALLIZED MARKINGS.
5. COMPLIANT TO JEDEC OUTLINE MO-205, NO EXACT VARIATION.
6. ALL DIMENSIONS APPLY TO BOTH LEADED (-) AND PbFREE (+) PKG. CODES.
7. PACKAGE CODES: X25-1, X25-2, X25-3

-DRAWING NOT TO SCALE-

		
TITLE: PACKAGE OUTLINE, 25 BALLS CSBGA, 5x5x1.0mm, 0.80 mm PITCH		
APPROVAL EDEN CHEN 08/24/10	DOCUMENT CONTROL NO. 21-0361	REV. B 1/1